



28V_{IN}, 3.3 to 15V_{OUT}, ZVS Isolated Converter Module Family

Product Description

The ZVS Isolated Converter Module Series consists of high density isolated DC-DC converters implementing Zero Voltage Switching topology.

The $28V_{IN}$ series operates over a wide range input of 16V to $50V_{DC}$, delivering 50W of output power, yielding an unprecedented power density of $334W/in^3$.

These converter modules are surface mountable and only ~.5" square in area achieving ~50% space reduction versus conventional solutions.

Device	Ou	I May	
Device	Set	Range	I _{OUT} Max
PI3108-00-HVMZ	MZ 3.3V 2.97 to 3.63V		10A
PI3109-00-HVMZ	5V	4 to 5.5V	10A
PI3106-00-HVMZ	12V	9.6 to 13.2V	4.2A
PI3111-00-HVMZ	15V	12 to 16.5V	3.33A

The switching frequency of 900kHz allows for small input and output filter components which further reduces the total size and cost of the overall system solution. The output voltage is sensed and fed back to the internal controller using a high performance isolated magnetic feedback scheme which allows for high bandwidth and good common mode noise immunity.

The PI31xx-00-HVMZ series requires no external feedback compensation and offers a total solution with a minimum number of external components. A rich feature set is offered, including output voltage trim capability, output over-voltage protection, adjustable soft-start, over-current protection with auto-restart, over and under input voltage lockout and a temperature monitoring and protection function that provides an analog voltage proportional to the die temperature as well as shut down and alarm capabilities.

Features

- Efficiency up to 88%
- High switching frequency minimizes input filter requirements and reduces output capacitance
- Proprietary "Double-Clamped" ZVS Buck-Boost Topology
- Proprietary isolated magnetic feedback
- Small footprint (0.57in²) enables PCB area savings
- Very low profile (0.265in)
- Wide input voltage range operation (16 50V_{DC})
- On/Off Control, positive logic
- Wide trim range +10/-20% most models
- Temperature Monitor (TM) & Overtemperature Protection (OTP)
- Input UVLO & OVLO and output OVP
- Overcurrent protection with auto restart
- Adjustable soft-start
- 2250V_{DC} input to output isolation
- Surface Mountable 0.87" x 0.65" x 0.265"

Applications

- Wide Temperature, Aerospace & Defense Applications
- Space Constrained Systems
- Isolated Board Level Power

Package Information

- Surface Mountable 0.87" x 0.65" x 0.265" package
- Weight = 7.8 grams





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Order Information

Part Number	V _{IN}	V _{OUT}	I _{OUT} Max	Package	Transport Media
PI3108-00-HVMZ	16 – 50V	3.3V	10A	0.87" x 0.65" x 0.265"	TRAY
PI3109-00-HVMZ	16 – 50V	5V	10A	0.87" x 0.65" x 0.265"	TRAY
PI3106-00-HVMZ	16 – 50V	12V	4.2A	0.87" x 0.65" x 0.265"	TRAY
PI3111-00-HVMZ	16 – 50V	15V	3.33A	0.87" x 0.65" x 0.265"	TRAY
			Also Available		
PI3101-00-HVIZ	36 – 75V	3.3V	18A	0.87" x 0.65" x 0.265"	TRAY
PI3105-00-HVIZ	36 – 75V	12V	5A	0.87" x 0.65" x 0.265"	TRAY
PI3110-01-HVIZ	41 – 57V	18V	3.3A	0.87" x 0.65" x 0.265"	TRAY
PI3109-01-HVIZ	18 – 36V	5V	10A	0.87" x 0.65" x 0.265"	TRAY
PI3106-01-HVIZ	18 – 36V	12V	4.2A	0.87" x 0.65" x 0.265"	TRAY

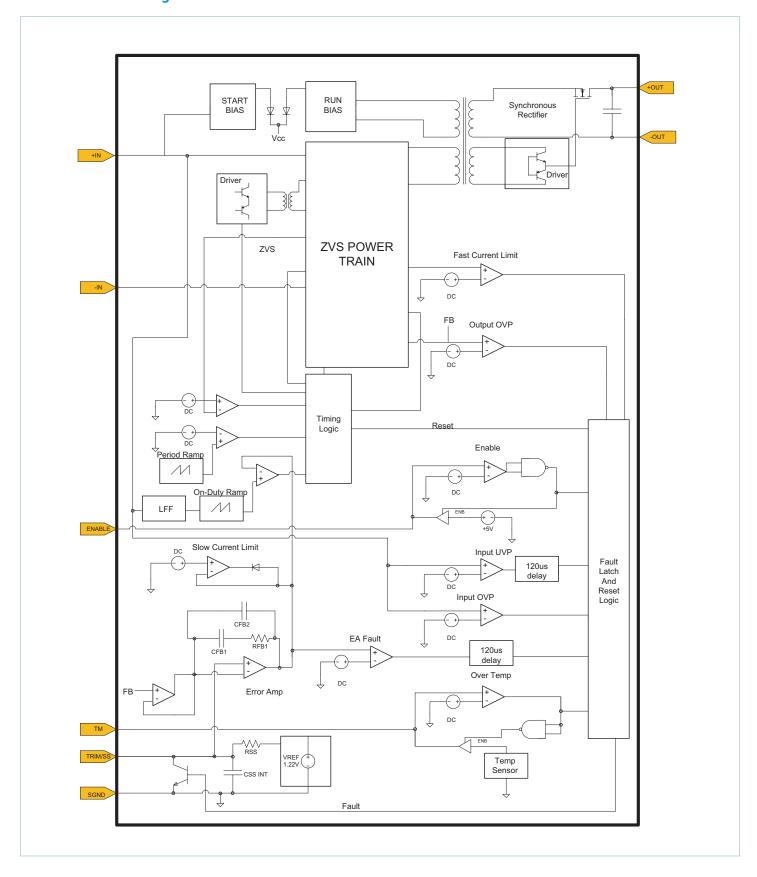


Absolute Maximum Ratings

Name	Rating
+IN to -IN Max Operating Voltage	-1.0 to 50V _{DC} (operating)
+IN to -IN Max Peak Voltage	55V _{DC} (non-operating, 12.5ms)
ENABLE to -IN	-0.3 to 6.0V _{DC}
TM to -IN	-0.3 to 6.0V _{DC}
TRIM/SS to -IN	-0.3 to 6.0V _{DC}
+OUT to -OUT	See relevant model output section
Isolation Voltage (+IN/–IN to +OUT/–OUT)	2250V _{DC}
Continuous Output Current	See relevant model output section
Peak Output Current	See relevant model output section
Operating Junction Temperature	-55 to 125°C
Storage Temperature	-65 to 125°C
Case Temperature During Reflow	245°C



Functional Block Diagram

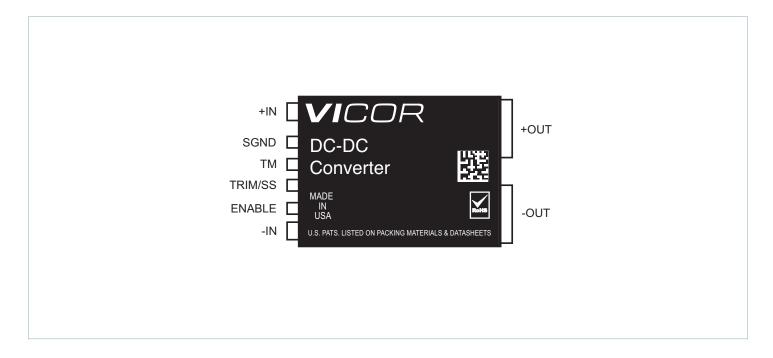




Pin Description

Pin Name	Description
+IN	Primary side positive input voltage terminals.
-IN	Primary side negative input voltage terminals.
ENABLE	Converter enable option, functions as 5V reference and on / off control pin. Pull low for off.
TRIM/SS	External soft start pin and trim function. Connect to SGND or ENABLE through resistor for trim up or trim down.
TM	Temperature measurement output pin.
SGND	Signal ground, primary side referenced.
+OUT	Isolated secondary DC output voltage positive terminals.
-OUT	Isolated secondary DC output voltage negative terminals.

Package Pin-Out





Unless otherwise specified: $16V < V_{IN} < 50V$, $0A < I_{OUT} < 10A$, $-55^{\circ}C < T_{CASE} < 100^{\circ}C$ [1]

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		Input Specifications				
Input Voltage Range	V _{IN}	input specifications	16	28	50	V _{DC}
Input dV/dt [1]	V _{INDVDT}	$V_{IN} = 50V$			1.0	V/µs
Input Undervoltage Turn-on	V _{UVON}	I _O = 10A	14.5	15.3	16	V _{DC}
Input Undervoltage Turn-off	V _{UVOFF}	I _O = 10A	13.5	14.1	15.2	V _{DC}
Input Undervoltage Hysteresis	V _{UVH}	$I_0 = 10A$	13.3	1.2	13.2	V _{DC}
Input Overvoltage Turn-on	V _{OVON}	$I_0 = 10A$	50	52.5	54	V _{DC}
Input Overvoltage Turn-off	Vovor	$I_0 = 10A$	51	53.7	55	V _{DC}
Input Overvoltage Hysteresis	VOVOFF	$I_0 = 10A$	J1	1.2	33	V _{DC}
Input Quiescent Current	I _O	$V_{IN} = 28V$, ENABLE = 0V		2		mA _{DC}
Input Idling Power		$V_{IN} = 28V$, LIVABLE = $0V$ $V_{IN} = 28V$, $I_{OUT} = 0A$		2.6		W
·	P _{IDLE}					W
Input Standby Power Input Current Full Load	P _{SBY}	V_{IN} = 28V, ENABLE = 0V T_{CASE} = 100°C, I_{OUT} = 10A, η_{FL} = 86% typical, V_{IN} = 28V		1.37		A _{DC}
Input Reflected Ripple Current	I _{INRR}	$L_{\text{IN}} = 0.47 \mu\text{H}$ $C_{\text{IN}} = 100 \mu\text{F}$ 63V electrolytic + 2 x 4.7 μF 50V X7R ceramic		15		mApp
Recommended Ext Input Capacitance	C _{IN}	$C_{IN} = 100 \mu F 63 V$ electrolytic + 2 x 4.7 μF 50V X7R ceramic $C_{IN} = Cbulk + Chf$		109.4		μF
		Output Specifications				
Output Voltage Set Point	V _{OUT}	I _{OUT} = 5A		3.3		V_{DC}
Table Communication	\ /	-0°C < T _{CASE} < 100°C	-3		+3	%
Total Output Accuracy	V_{OA}	-55°C < T _{CASE} < 0°C	-5		+3	%
Output Voltage Trim Range	V _{OADJ}		-10		10	%
Output Current Range	I _{OUT}				10	A _{DC}
Overcurrent Protection	I _{OCP}		11.0	15	20	A _{DC}
Efficiency – Full Load	$\eta_{\scriptscriptstyle{FI}}$	T _{CASE} = 100°C, V _{IN} = 28V	84	86		%
Efficiency – Half Load	η_{HL}	T _{CASE} = 100°C, V _{IN} = 28V	80	82		%
Output OVP Set Point	V _{OVP}		3.9	4.1	4.3	V_{DC}
Output Ripple Voltage	V _{ORPP}	C _{OUT} = 6 x 10µF 10V X7R DC-20MHz		90		mVpp
Switching Frequency	f _{SW}			900		kHz
Output Turn-on Delay Time	t _{ONDLY}	$V_{IN} = V_{UVON}$ to ENABLE = 5V; V_{IN} rise time < 1ms		80		ms
Output Turn-off Delay Time	t _{OFFDLY}	V _{IN} = V _{UVOFF} to ENABLE < 2.35V		375		μs
Soft-Start Ramp Time	t _{SS}	ENABLE = 5V to 90% V _{OUT} C _{RFF} = 0		380		μs
Maximum Load Capacitance	C _{OUT}	$C_{REF} = 0.22 \mu F$, $C_{OUT} = Al$ Electrolytic			4700	μF
Load Transient Deviation	V _{ODV}	$I_{OUT} = 50\%$ step 0.1A/ μ S $C_{OUT} = 6 \times 10 \mu$ F 10V X7R		145		mV
Load Transient Recovery Time	t _{OVR}	I _{OUT} = 50% step 0.1A/μS C _{OUT} = 6 x 10μF 10V X7R V _{OUT} - 1%		100		μs
Maximum Output Power	P _{OUT}			33		W
		Absolute Maximum Output Ratings				
Name		Rating				
+OUT to -OUT		-0.5V to 6.8V _{DC}				
Continuous Output Current		10A _{DC}				
Peak Output Current		20A _{DC}				

^[1] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.



^[2] Current flow sourced by a pin has a negative sign.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
DCIVIL D.C.		ENABLE	4.65	4.0	F 4 F	.,
DC Voltage Reference Output	V _{ERO}	FMARIE 2 2V	4.65	4.9	5.15	V _{DC}
Output Current Limit [2]	I _{ECL}	ENABLE = 3.3V	-3.3	-2.6	-1.9	mA _{DC}
Start Up Current Limit [2]	I _{ESL}	ENABLE = 1V	-120	-90	-60	μA
Module Enable Voltage	V _{EME}		1.95	2.5	3.05	V _{DC}
Module Disable Voltage	V _{EMD}			2.35		V _{DC}
Disable Hysteresis	V _{EDH}			150		mV
Enable Delay Time	t _{EE}			10		μs
Disable Delay Time	t _{ED}			10		μs
Maximum Capacitance	C _{EC}				1500	pF
Maximum External Toggle Rate	f _{EXT}				1	Hz
		TRIM/SS		I		I
Trim Voltage Reference	V_{REF}			1.240		V _{DC}
Internal Capacitance	C _{REFI}			10		nF
External Capacitance	C _{REF}				0.22	μF
Internal Resistance	R _{REFI}			10		kΩ
		TM (Temperature Monitor)				
Temperature Coefficient [1]	TM_TC			10		mV / °K
Temperature Full Range Accuracy [1]	TM_{ACC}		-5		5	°K
Drive Capability	I _{TM}		-100			μA
TM Output Setting	V_{TM}	Ambient Temperature = 300°K		3.00		V
		The control of the state of				
	-	Thermal Specification	120	425	4.40	0.5
Junction Temperature Shutdown [1]	T _{MAX}		130	135	140	°C
Junction-to-Case Thermal Impedance	RΘ _{J-C}	M		3		°C / W
Case-to-Ambient Thermal Impedance	R⊖ _{C-A}	Mounted on 9in ² 1oz. Cu 6 layer PCB 25°C		9.6		°C / W
		Regulatory Specification				
IEC 60950-1:2005 (2nd Edition)						
EN 60950-1:2006						
IEC 61000-4-2						
UL60950-1:2007						
CAN/CSA C22.2 NO. 60950-1-07						
Recommended Input Fuse Rating	I _{FUSE}	Fast acting LITTLEFUSE Nano ² Series Fuse	4		10	А

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^[2] Current flow sourced by a pin has a negative sign.

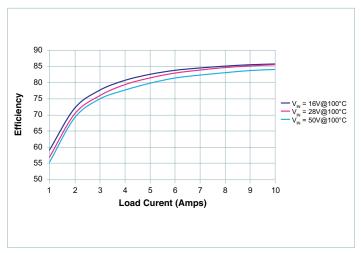


Figure 1 — Conversion Efficiency

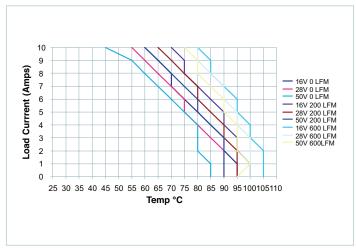


Figure 2 — Load Current vs Temperature (without Heat Sink)

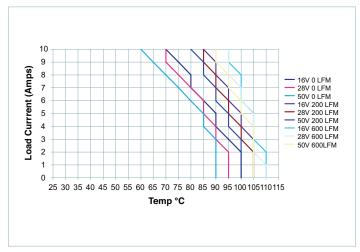


Figure 3 — Load Current vs Temperature (6.33mm Heat Sink)

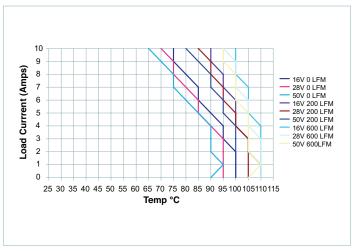


Figure 4 — Load Current vs Temperature (11mm Heat Sink)

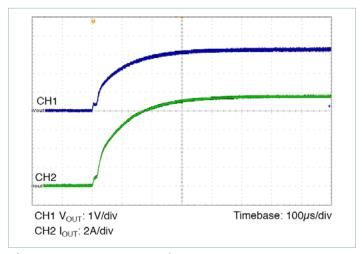


Figure 5 — Start Up, $C_{REF} = 0$ ($V_{IN} = 16V$, $I_{OUT} = 10A$, CR, $C_{OUT} = 6 \times 10 \mu F$ X7R Ceramic)

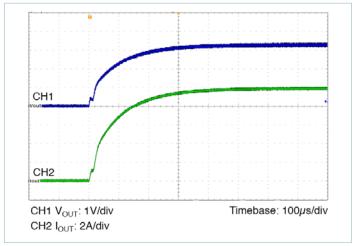


Figure 6 — Start Up, $C_{REF} = 0$ ($V_{IN} = 28V$, $I_{OUT} = 10A$, CR, $C_{OUT} = 6 \times 10 \mu F$ X7R Ceramic)



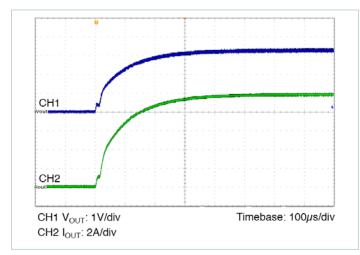


Figure 7 — Start Up, $C_{REF} = 0$ ($V_{IN} = 50V$, $I_{OUT} = 10A$, CR, $C_{OUT} = 6 \times 10 \mu F X7R$ Ceramic)

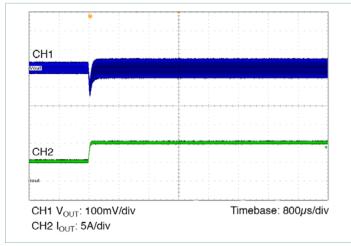


Figure 8 — Transient Response ($V_{IN} = 28V$, $I_{OUT} = 5 - 10A$, 0.1A/ μ s, $C_{OUT} = 6 \times 10 \mu$ F X7R Ceramic)

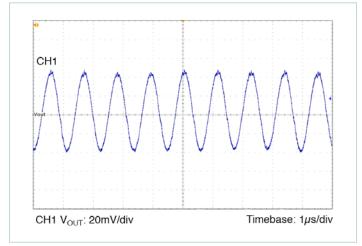


Figure 9 — Output Ripple ($V_{IN} = 28V$, $I_{OUT} = 10A$, CR, $C_{OUT} = 6 \times 10 \mu F X7R$ Ceramic)



Figure 10 — Thermal Image $(V_{IN} = 28V, I_{OUT} = 10A, CR, OLFM Evaluation PCB)$



Unless otherwise specified: $16V < V_{IN} < 50V$, $0A < I_{OUT} < 10A$, $-55^{\circ}C < T_{CASE} < 100^{\circ}C$ [1]

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		Input Specifications				
Input Voltage Range	V _{IN}	input specifications	16	28	50	V _{DC}
Input dV/dt [1]	V _{INDVDT}	$V_{IN} = 50V$	10	20	1.0	V/µs
Input Undervoltage Turn-on	V _{UVON}	$I_{O} = 10A$	14.5	15.3	16	V _{DC}
Input Undervoltage Turn-off	V _{UVOFF}	I _O = 10A	13.5	14.1	15.2	V _{DC}
Input Undervoltage Hysteresis	VUVOFF	$I_0 = 10A$	13.3	1.2	13.2	V _{DC}
Input Overvoltage Turn-on	V _{OVON}	$I_0 = 10A$	50.0	52.5	54	V _{DC}
Input Overvoltage Turn-off		$I_0 = 10A$ $I_0 = 10A$	50.0	53.7	55	
	V _{OVOFF}	 	31		55	V _{DC}
Input Overvoltage Hysteresis	V _{OVH}	I _O = 10A		1.2		V _{DC}
Input Quiescent Current	IQ	$V_{IN} = 28V$, ENABLE = 0V		2		mA _{DC}
Input Idling Power	P _{IDLE}	$V_{IN} = 28V$, $I_{OUT} = 0A$		3.5		W
Input Standby Power	P _{SBY}	$V_{IN} = 28V$, ENABLE = 0V		0.056		W
Input Current Full Load	I _{IN}	T_{CASE} = 100°C, I_{OUT} = 10A, η_{FL} = 88% typical, V_{IN} = 28V		2.03		A _{DC}
Input Reflected Ripple Current	I _{INRR}	L_{IN} = 0.47μH C_{IN} = 100μF 63V electrolytic + 2 x 4.7μF 50V X7R ceramic		13		mApp
Recommended Ext Input Capacitance	C_IN	C_{IN} = 100 μ F 63V electrolytic + 2 x 4.7 μ F 50V X7R ceramic C_{IN} = Cbulk + Chf		109.4		μF
		Output Specifications				
Output Voltage Set Point	V _{OUT}	I _{OUT} = 5A		5.0		V_{DC}
		-0°C < T _{CASE} < 100°C	-3		+3	%
Total Output Accuracy	V_{OA}	-55°C < T _{CASE} < 0°C	-5		+3	%
Output Voltage Trim Range	V _{OADJ}		-20		10	%
Output Current Range	I _{OUT}				10	A _{DC}
Overcurrent Protection	I _{OCP}		10.8	15	20	A _{DC}
Efficiency – Full Load	$\eta_{\sf Fl}$	$T_{CASF} = 100^{\circ}C$, $V_{IN} = 28V$	86	88		%
Efficiency – Half Load	η_{HL}	$T_{CASE} = 100^{\circ}C$, $V_{IN} = 28V$	83.5	85.5		%
Output OVP Set Point	V _{OVP}	7 11	6.0	6.3	6.6	V _{DC}
Output Ripple Voltage	V _{ORPP}	C _{OUT} = 6 x 10μF 10V X7R DC-20MHz		135		mVpp
Switching Frequency	f _{SW}			900		kHz
Output Turn-on Delay Time	tondly	$V_{IN} = V_{UVON}$ to ENABLE = 5V; V_{IN} rise time < 1ms		80		ms
Output Turn-off Delay Time	t _{OFFDLY}	$V_{IN} = V_{UVOFF}$ to ENABLE < 2.35V		375		μs
Soft-Start Ramp Time	t _{SS}	ENABLE = 5V to 90% V _{OUT} C _{RFF} = 0		230		μs
Maximum Load Capacitance	C _{OUT}	$C_{REF} = 0.22 \mu F$, $C_{OUT} = AI$ Electrolytic		250	4700	μF
Load Transient Deviation	V _{ODV}	$I_{OUT} = 50\%$ step 0.1A/ μ S $C_{OUT} = 6 \times 10 \mu F$ 10V X7R		90	4700	mV
Load Transient Recovery Time	t _{OVR}	I _{OUT} = 50 % step 0.1A/μS C _{OUT} = 6 x 10μF 10V X7R V _{OUT} - 1%		100		μs
Maximum Output Power	Pout			50		W
		Absolute Maximum Output Ratings				
Name		Rating				
+OUT to -OUT		-0.5V to 6.8V _{DC}				
Continuous Output Current		10A _{DC}				
Peak Output Current		20A _{DC}				

^[1] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.



^[2] Current flow sourced by a pin has a negative sign.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		FNADIF				
DC Voltage Reference Output	\/	ENABLE	4.65	4.0	F 1F	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
DC Voltage Reference Output	V _{ERO}	ENABLE 2 2V	4.65	4.9	5.15	V _{DC}
Output Current Limit [2]	I _{ECL}	ENABLE = 3.3V	-3.3	-2.6	-1.9	mA _{DC}
Start Up Current Limit [2]	I _{ESL}	ENABLE = 1V	-120	-90	-60	μA
Module Enable Voltage	V _{EME}		1.95	2.5	3.05	V _{DC}
Module Disable Voltage	V _{EMD}		1.8	2.35	2.9	V _{DC}
Disable Hysteresis	V _{EDH}			150		mV
Enable Delay Time	t _{EE}			10		μs
Disable Delay Time	t _{ED}			10		μs
Maximum Capacitance	C _{EC}				1500	pF
Maximum External Toggle Rate	f _{EXT}				1	Hz
		TRIM/SS				
Trim Voltage Reference	V_{REF}			1.240		V_{DC}
Internal Capacitance	C_{REFI}			10		nF
External Capacitance	C_REF				0.22	μF
Internal Resistance	R _{REFI}			10		kΩ
		TM (Temperature Monitor)				
Temperature Coefficient [1]	TM_TC			10		mV / °K
Temperature Full Range Accuracy [1]	TM _{ACC}		-5		5	°K
Drive Capability	I _{TM}		-100			μΑ
TM Output Setting	V_{TM}	Ambient Temperature = 300°K		3.00		V
		Thermal Specification				
Junction Temperature Shutdown [1]	т	Thermal Specification	130	135	140	°C
	T _{MAX}		130		140	
Junction-to-Case Thermal Impedance	RΘ _{J-C}	Manustad as 0is 2 face Cu Clause DCD 250C		3		°C / W
Case-to-Ambient Thermal Impedance	RΘ _{C-A}	Mounted on 9in ² 1oz. Cu 6 layer PCB 25°C		9.1		°C / W
		Regulatory Specification				
IEC 60950-1:2005 (2nd Edition)						
EN 60950-1:2006						
IEC 61000-4-2						
UL60950-1:2007						
CAN/CSA C22.2 NO. 60950-1-07						
Recommended Input Fuse Rating	I _{FUSE}	Fast acting LITTLEFUSE Nano ² Series Fuse	4		10	А

^[1] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.



^[2] Current flow sourced by a pin has a negative sign.

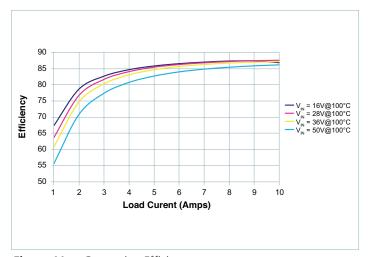


Figure 11 — Conversion Efficiency

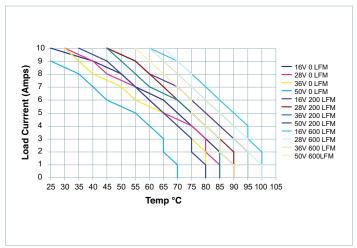


Figure 12 — Load Current vs Temperature (without Heat Sink)

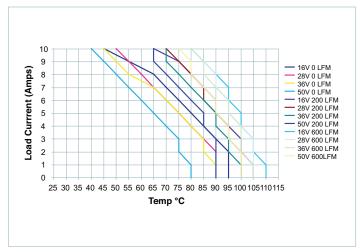


Figure 13 — Load Current vs Temperature (6.33mm Heat Sink)

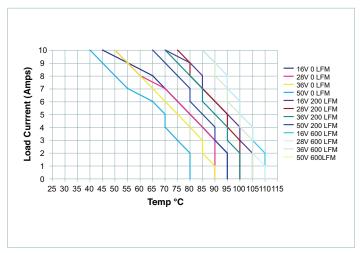


Figure 14 — Load Current vs Temperature (11mm Heat Sink)

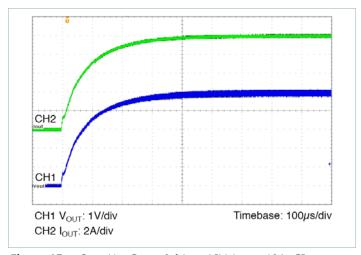


Figure 15 — Start Up, $C_{REF} = 0$ ($V_{IN} = 16V$, $I_{OUT} = 10A$, CR, $C_{OUT} = 6 \times 10 \mu F$ X7R Ceramic)

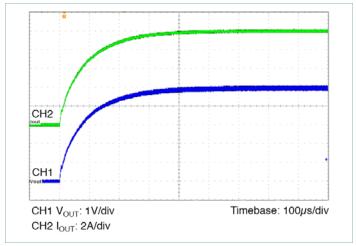


Figure 16 — Start Up, $C_{REF} = 0$ ($V_{IN} = 28V$, $I_{OUT} = 10A$, CR, $C_{OUT} = 6 \times 10 \mu F$ X7R Ceramic)



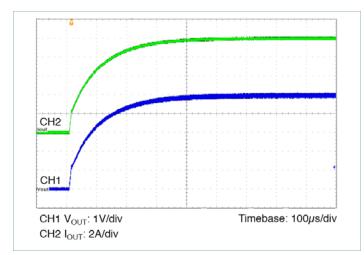


Figure 17 — Start Up, $C_{REF} = 0$ ($V_{IN} = 50V$, $I_{OUT} = 10A$, CR, $C_{OUT} = 6 \times 10 \mu F$ X7R Ceramic)

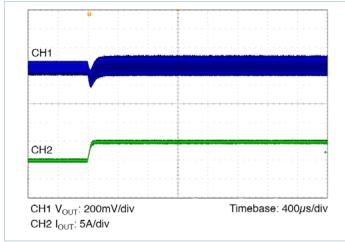


Figure 18 — Transient Response ($V_{IN} = 28V$, $I_{OUT} = 5 - 10A$, 0.1A/ μ s, $C_{OUT} = 6 \times 10 \mu$ F X7R Ceramic)

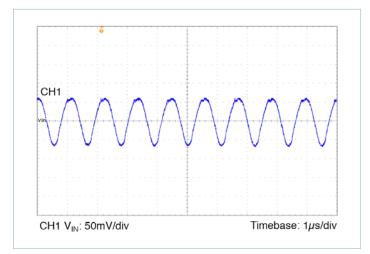


Figure 19 — Output Ripple ($V_{IN} = 28V$, $I_{OUT} = 10A$, CR, $C_{OUT} = 6 \times 10 \mu F X7R$ Ceramic)



Figure 20 — Thermal Image ($V_{IN} = 28V$, $I_{OUT} = 10A$, CR, OLFM Evaluation PCB)

Unless otherwise specified: 16V < V_{IN} < 50V, 0A < I_{OUT} < 4.2A, -55°C < T_{CASE} < 100°C [1]

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		Input Specifications				
Input Voltage Range	V _{IN}	input specifications	16	28	50	V _{DC}
Input dV/dt [1]	V _{INDVDT}	$V_{IN} = 50V$	10	20	1.0	V/µs
Input Undervoltage Turn-on	V _{UVON}	$I_{O} = 4.2A$	14.5	15.4	1.6	V _{DC}
Input Undervoltage Turn-off	V _{UVOFF}	$I_0 = 4.2A$	13.5	14.4	15.2	V _{DC}
Input Undervoltage Hysteresis	VUVOFF	$I_0 = 4.2A$	13.3	1.0	13.2	V _{DC}
Input Overvoltage Turn-on	V _{OVON}	$I_0 = 4.2A$	50	52.3	54	V _{DC}
Input Overvoltage Turn-off		$I_0 = 4.2A$ $I_0 = 4.2A$	51	53.5	55	
	V _{OVOFF}		51		55	V _{DC}
Input Overvoltage Hysteresis	V _{OVH}	I ₀ = 4.2A		1.2		V _{DC}
Input Quiescent Current	IQ	$V_{IN} = 28V$, ENABLE = 0V		2		mA _{DC}
Input Idling Power	P _{IDLE}	$V_{IN} = 28V, I_{OUT} = 0A$		3.5		W
Input Standby Power	P _{SBY}	$V_{IN} = 28V$, ENABLE = $0V$		0.056		W
Input Current Full Load	I _{IN}	T_{CASE} = 100°C, I_{OUT} = 4.2A, η_{FL} = 88% typical, V_{IN} = 28V		2.045		A _{DC}
Input Reflected Ripple Current	I _{INRR}	L_{IN} = 0.47 μ H C_{IN} = 100 μ F 63V electrolytic + 2 x 4.7 μ F 50V X7R ceramic		13		mApp
Recommended Ext Input Capacitance	C_IN	C_{IN} = 100 μ F 63V electrolytic + 2 x 4.7 μ F 50V X7R ceramic C_{IN} = Cbulk + Chf		109.4		μF
		Output Specifications				
Output Voltage Set Point	V_{OUT}	I _{OUT} = 2.1A		12.0		V_{DC}
T. 10		-0°C < T _{CASE} < 100°C	-3		+3	%
Total Output Accuracy	V_{OA}	-55°C < T _{CASE} < 0°C	-5		+3	%
Output Voltage Trim Range	V_{OADJ}		-20		10	%
Output Current Range	I _{OUT}				4.2	A _{DC}
Overcurrent Protection	I _{OCP}		4.6	6.8	12	A _{DC}
Efficiency – Full Load	$\eta_{\sf Fl}$	$T_{CASF} = 100^{\circ}C$, $V_{IN} = 28V$	86	88		%
Efficiency – Half Load	η _{HL}	$T_{CASE} = 100^{\circ}C$, $V_{IN} = 28V$	83	85		%
Output OVP Set Point	V _{OVP}	Cross 7 IIV	13.8	14.6	15.3	V _{DC}
Output Ripple Voltage	V _{ORPP}	C _{OUT} = 6 x 2.2µF 16V X7R DC-20MHz		150		mVpp
Switching Frequency	f _{SW}			900		kHz
Output Turn-on Delay Time	t _{ONDLY}	$V_{IN} = V_{UVON}$ to ENABLE = 5V; V_{IN} rise time < 1ms		80		ms
Output Turn-off Delay Time	torfdly	$V_{IN} = V_{UVOFF}$ to ENABLE < 2.35V		375		μs
Soft-Start Ramp Time	t _{SS}	ENABLE = 5V to 90% V _{OLIT} C _{REF} = 0		230		μs
Maximum Load Capacitance	C _{OUT}	$C_{REF} = 0.22 \mu F$, $C_{OUT} = AI$ Electrolytic		230	1000	μF
Load Transient Deviation	V _{ODV}	$I_{OUT} = 50\%$ step 0.1A/ μ S $C_{OUT} = 6 \times 2.2 \mu$ F 16V X7R		360	1000	mV
Load Transient Recovery Time	t _{OVR}	I _{OUT} = 50% step 0.1A/μS C _{OUT} = 6 x 2.2μF 16V X7R V _{OUT} - 1%		100		μs
Maximum Output Power	P _{OUT}			50		W
		Absolute Maximum Output Ratings				
Name		Rating				
+OUT to -OUT		-0.5V to 16V _{DC}				
Continuous Output Current		4.2A _{DC}				
Peak Output Current		12A _{DC}				

^[1] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.



^[2] Current flow sourced by a pin has a negative sign.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		ENABLE				
DC Voltage Reference Output	V _{ERO}	ENABLE	4.65	4.9	5.15	\/
Output Current Limit [2]		ENIABLE 2.2V	-3.3	-2.6	-1.9	V _{DC}
Start Up Current Limit [2]	I _{ECL}	ENABLE = 3.3V ENABLE = 1V	-3.3 -120		-60	mA _{DC}
	I _{ESL}	ENABLE = IV		-90		μΑ
Module Enable Voltage	V _{EME}		1.95	2.5	3.05	V _{DC}
Module Disable Voltage	V _{EMD}		1.8	2.35	2.9	V _{DC}
Disable Hysteresis	V _{EDH}			150		mV
Enable Delay Time	t _{EE}			10		μs
Disable Delay Time	t _{ED}			10		μs
Maximum Capacitance	C _{EC}				1500	pF
Maximum External Toggle Rate	f _{EXT}				1	Hz
		TRIM/SS				
Trim Voltage Reference	V_{REF}			1.235		V _{DC}
Internal Capacitance	C_{REFI}			10		nF
External Capacitance	C_REF				0.22	μF
Internal Resistance	R _{REFI}			10		kΩ
		TM (Temperature Monitor)				
Temperature Coefficient [1]	TM _{TC}			10		mV / °K
Temperature Full Range Accuracy [1]	TM _{ACC}		-5		5	°K
Drive Capability	I _{TM}		-100			μA
TM Output Setting	V_{TM}	Ambient Temperature = 300°K		3.00		V
		Thermal Specification		T	I	I
Junction Temperature Shutdown [1]	T _{MAX}		130	135	140	°C
Junction-to-Case Thermal Impedance	$R\Theta_{J-C}$			3		°C / W
Case-to-Ambient Thermal Impedance	R⊕ _{C-A}	Mounted on 9in ² 1oz. Cu 6 layer PCB 25°C		8.15		°C / W
		Regulatory Specification				
IEC 60950-1:2005 (2nd Edition)						
EN 60950-1:2006						
IEC 61000-4-2						
UL60950-1:2007						
CAN/CSA C22.2 NO. 60950-1-07						
Recommended Input Fuse Rating	I _{FUSE}	Fast acting LITTLEFUSE Nano ² Series Fuse	4		10	А

^[1] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.



^[2] Current flow sourced by a pin has a negative sign.

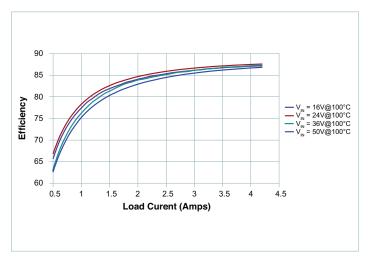


Figure 21 — Conversion Efficiency

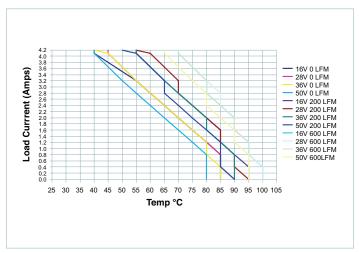


Figure 22 — Load Current vs Temperature (without Heat Sink)

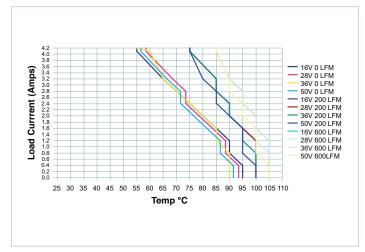


Figure 23 — Load Current vs Temperature (6.3mm Heat Sink)

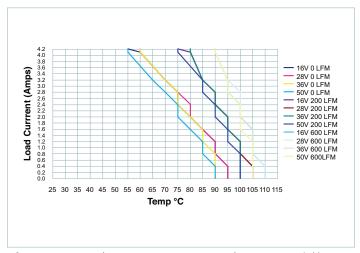


Figure 24 — Load Current vs Temperature (11mm Heat Sink)

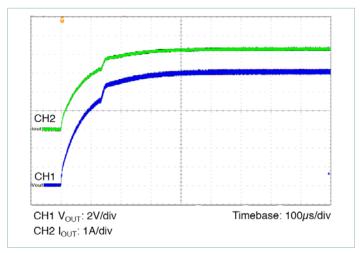


Figure 25 — Start Up, $C_{REF} = 0$ ($V_{IN} = 16V$, $I_{OUT} = 4.2A$, CR, $C_{OUT} = 6 \times 2.2 \mu F$ X7R Ceramic)

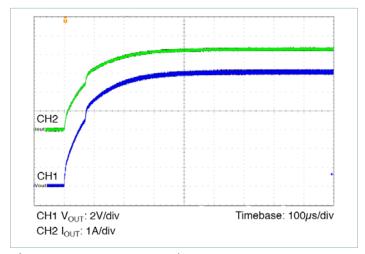


Figure 26 — Start Up, $C_{REF} = 0$ ($V_{IN} = 28V$, $I_{OUT} = 4.2A$, CR, $C_{OUT} = 6 \times 2.2 \mu F$ X7R Ceramic)



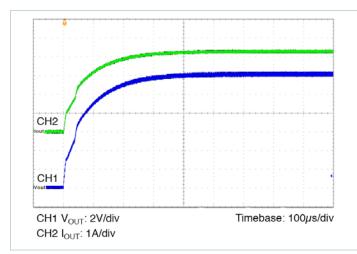


Figure 27 — Start Up, $C_{REF} = 0$ ($V_{IN} = 50V$, $I_{OUT} = 4.2A$, CR, $C_{OUT} = 6 \times 2.2 \mu F$ X7R Ceramic)

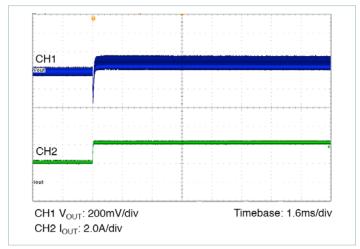


Figure 28 — Transient Response (V_{IN} = 28V I_{OUT} = 2.1 – 4.2A, 0.1A/ μ s, C_{OUT} = 6 X 2.2 μ F X7R Ceramic)

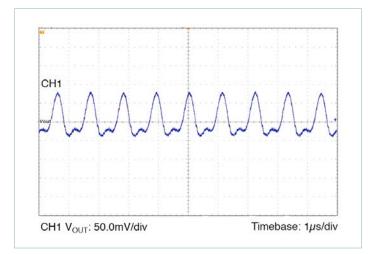


Figure 29 — Output Ripple ($V_{IN} = 28V I_{OUT} = 4.2A$, $C_{OUT} = 6 \times 2.2 \mu F X7R$ Ceramic)



Figure 30 — Thermal Image ($V_{IN} = 28V$, $I_{OUT} = 4.2A$, CR, OLFM Evaluation PCB)

Unless otherwise specified: 16V < V_{IN} < 50V, 0A < I_{OUT} < 3.3A, -55°C < T_{CASE} < 100°C [1]

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		Input Specifications				
Input Voltage Range	V _{IN}	input specifications	16	28	50	V _{DC}
Input dV/dt [1]	V _{INDVDT}	$V_{IN} = 50V$	10	20	1.0	V/µs
Input Undervoltage Turn-on	V _{UVON}	$I_{O} = 3.3A$	14.5	15.4	1.6	V _{DC}
Input Undervoltage Turn-off	V _{UVOFF}	I ₀ = 3.3A	13.5	14.3	15.2	V _{DC}
Input Undervoltage Hysteresis	VUVOFF	$I_0 = 3.3A$	13.3	1.1	13.2	V _{DC}
Input Overvoltage Turn-on	V _{OVON}	$I_0 = 3.3A$	50	52.4	54	V _{DC}
Input Overvoltage Turn-off		$I_0 = 3.3A$ $I_0 = 3.3A$	51	53.5	55	
	V _{OVOFF}		31		55	V _{DC}
Input Overvoltage Hysteresis	V _{OVH}	I ₀ = 3.3A		1.1		V _{DC}
Input Quiescent Current	IQ	$V_{IN} = 28V$, ENABLE = 0V		2		mA _{DC}
Input Idling Power	P _{IDLE}	$V_{IN} = 28V$, $I_{OUT} = 0A$		4.1		W
Input Standby Power	P _{SBY}	$V_{IN} = 28V$, ENABLE = 0V		0.056		W
Input Current Full Load	I _{IN}	T_{CASE} = 100°C, I_{OUT} = 3.3A, η_{FL} = 87.5% typical, V_{IN} = 28V		2.039		A_{DC}
Input Reflected Ripple Current	I _{INRR}	L_{IN} = 0.47 μ H C_{IN} = 100 μ F 63V electrolytic + 2 x 4.7 μ F 50V X7R ceramic		13		mApp
Recommended Ext Input Capacitance	C_IN	C_{IN} = 100 μ F 63V electrolytic + 2 x 4.7 μ F 50V X7R ceramic C_{IN} = Cbulk + Chf		109.4		μF
		Output Specifications				
Output Voltage Set Point	V _{OUT}	I _{OUT} = 1.65A		15.0		V_{DC}
		-0°C < T _{CASE} < 100°C	-3		+3	%
Total Output Accuracy	V_{OA}	-55°C < T _{CASE} < 0°C	-5		+3	%
Output Voltage Trim Range	V _{OADJ}		-20		10	%
Output Current Range	I _{OUT}				3.3	A _{DC}
Overcurrent Protection	I _{OCP}		3.8	5.6	9.6	A _{DC}
Efficiency – Full Load	η _{FI}	$T_{CASF} = 100^{\circ}C$, $V_{IN} = 28V$	85.5	87.5		%
Efficiency – Half Load	' _{۲∟}	$T_{CASE} = 100^{\circ}C$, $V_{IN} = 28V$	82.3	84.3		%
Output OVP Set Point	V _{OVP}	CASE 132 2/ 1/14 221	17.6	18.2	18.8	V _{DC}
Output Ripple Voltage	V _{ORPP}	C _{OUT} = 6 x 2.2µF 16V X7R DC-20MHz		275		mVpp
Switching Frequency	f _{SW}	COOT = 0 X 2.2 pt 10 V XX X B C 20 W 12		900		kHz
Output Turn-on Delay Time	tondly	$V_{IN} = V_{UVON}$ to ENABLE = 5V; V_{IN} rise time < 1ms		80		ms
Output Turn-off Delay Time	t _{OFFDLY}	$V_{IN} = V_{UVOFF}$ to ENABLE < 2.35V		375		μs
Soft-Start Ramp Time		ENABLE = 5V to 90% V _{OUT} C _{RFF} = 0		230		
Maximum Load Capacitance	t _{ss} C _{out}	$C_{REF} = 0.22 \mu F$, $C_{OUT} = AI$ Electrolytic		230	1000	μs
Load Transient Deviation	V _{ODV}	$I_{OUT} = 50\%$ step 0.1A/ μ S $C_{OUT} = 6 \times 2.2 \mu$ F 16V X7R		375	1000	μF mV
Load Transient Recovery Time	t _{ovr}	I _{OUT} = 50% step 0.1A/μS C _{OUT} = 6 x 2.2μF 16V X7R V _{OUT} - 1%		100		μs
Maximum Output Power	P _{OUT}			50		W
		Absolute Maximum Output Ratings	·			
Name		Rating				
+OUT to -OUT		-0.5V to 20V _{DC}				
Continuous Output Current		3.3A _{DC}				
Peak Output Current		9.6A _{DC}				

^[1] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.



^[2] Current flow sourced by a pin has a negative sign.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
		FNARIE				
DC Valtana Dafanana Outrot		ENABLE	4.65	4.0	F 1F	
DC Voltage Reference Output	V _{ERO}	EMARKE 2.2V	4.65	4.9	5.15	V _{DC}
Output Current Limit [2]	l _{ECL}	ENABLE = 3.3V	-3.3	-2.6	-1.9	mA _{DC}
Start Up Current Limit [2]	I _{ESL}	ENABLE = 1V	-120	-90	-60	μA
Module Enable Voltage	V _{EME}		1.95	2.5	3.05	V _{DC}
Module Disable Voltage	V _{EMD}		1.8	2.35	2.9	V _{DC}
Disable Hysteresis	V _{EDH}			150		mV
Enable Delay Time	t _{EE}			10		μs
Disable Delay Time	t _{ED}			10		μs
Maximum Capacitance	C _{EC}				1500	pF
Maximum External Toggle Rate	f _{EXT}				1	Hz
		TRIM/SS				
Tiin Valta as Defenses	\/	I KIIVI/55		1 220		
Trim Voltage Reference	V _{REF}			1.230		V _{DC}
Internal Capacitance	C _{REFI}			10	0.22	nF
External Capacitance	C _{REF}				0.22	μF
Internal Resistance	R _{REFI}			10		kΩ
		TM (Temperature Monitor)				
Temperature Coefficient [1]	TM_{TC}			10		mV / °K
Temperature Full Range Accuracy [1]	TM _{ACC}		-5		5	°K
Drive Capability	I _{TM}		-100			μΑ
TM Output Setting	V_{TM}	Ambient Temperature = 300°K		3.00		V
		Thermal Specification				
Junction Temperature Shutdown [1]	T_{MAX}		130	135	140	°C
Junction-to-Case Thermal Impedance	$R\Theta_{J-C}$			3		°C / W
Case-to-Ambient Thermal Impedance	$R\Theta_{C-A}$	Mounted on 9in ² 1oz. Cu 6 layer PCB 25°C		9.39		°C / W
IEC 600E0 1:200E (2nd Edition)		Regulatory Specification				
IEC 60950-1:2005 (2nd Edition)						
EN 60950-1:2006						
IEC 61000-4-2						
UL60950-1:2007						
CAN/CSA C22.2 NO. 60950-1-07						
Recommended Input Fuse Rating	I _{FUSE}	Fast acting LITTLEFUSE Nano ² Series Fuse	4		10	А

^[1] These parameters are not production tested but are guaranteed by design, characterization and correlation with statistical process control. Unless otherwise specified, ATE tests are completed at room temperature.



^[2] Current flow sourced by a pin has a negative sign.

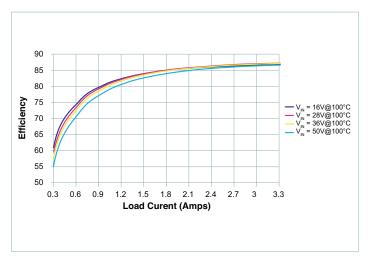


Figure 31 — Conversion Efficiency

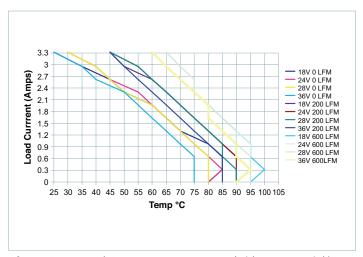


Figure 32 — Load Current vs Temperature (without Heat Sink)

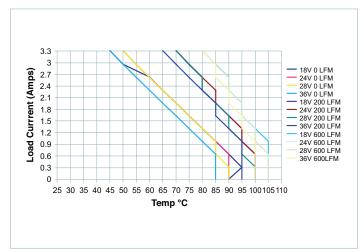


Figure 33 — Load Current vs Temperature (6.33mm Heat Sink)

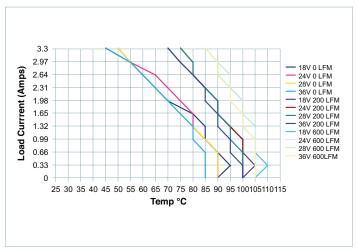


Figure 34 — Load Current vs Temperature (11mm Heat Sink)

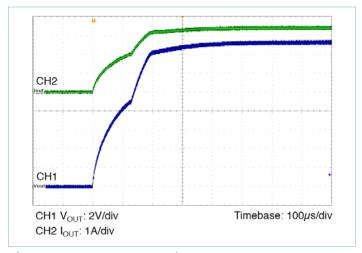


Figure 35 — Start Up, $C_{REF} = 0$ ($V_{IN} = 16V$, $I_{OUT} = 3.3A$, CR, $C_{OUT} = 6 \times 2.2 \mu F$ X7R Ceramic)

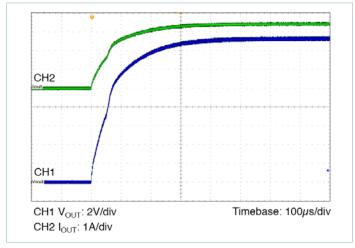


Figure 36 — Start Up, $C_{REF} = 0$ ($V_{IN} = 28V$, $I_{OUT} = 3.3A$, CR, $C_{OUT} = 6 \times 2.2 \mu F$ X7R Ceramic)



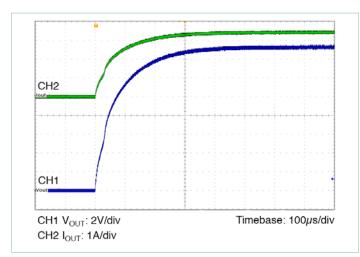


Figure 37 — Start Up, $C_{REF} = 0$ ($V_{IN} = 50V$, $I_{OUT} = 3.3A$, CR, $C_{OUT} = 6 \times 2.2 \mu F$ X7R Ceramic)

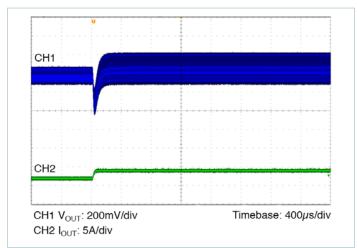


Figure 38 — Transient Response ($V_{IN} = 28V$, $I_{OUT} = 1.65 - 3.3A$, $0.1A/\mu s$, $C_{OUT} = 6 \times 2.2 \mu F X7R$ Ceramic)

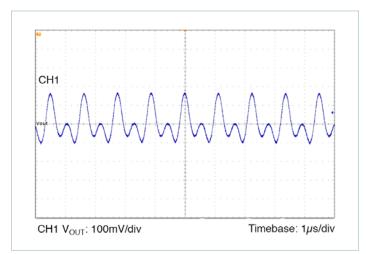


Figure 39 — Output Ripple (V_{IN} = 28V, I_{OUT} = 3.3A, C_{OUT} = 6 X 2.2 μ F X7R Ceramic)



Figure 40 — Thermal Image ($V_{IN} = 28V$, $I_{OUT} = 3.33A$, CR, OLFM Evaluation PCB)

Functional Description

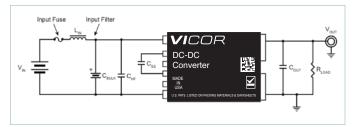


Figure 41 — Picor PI31xx-00-HVMZ Shown With System Fuse, Filter, Decoupling And Extended Soft Start

Input Power Pins IN(+) and IN(-)

The input power pins on the PI31xx-00-HVMZ are connected to the input power source which can range from 16V to 50V_{DC}. Under surge conditions, the PI31xx-00-HVMZ can withstand up to 55V_{DC} for 12.5ms without incurring damage. The user should take care to avoid driving the input rails above the specified ratings. Since the PI31xx-00-HVMZ is designed with high reliability in mind, the input pins are continuously monitored. If the applied voltage exceeds the input overvoltage trip point (typically 53.5V) the conversion process shall be terminated immediately. The converter initiates soft-start automatically within 80ms after the input voltage is reduced back to the appropriate value. The input pins do not have reverse polarity protection. If the PI31xx-00-HVMZ is operated in an environment where reverse polarity is a concern, the user should consider using a polarity protection device such as a suitably rated diode. To avoid the high losses of using a diode, the user should consider the much higher efficiency Picor family of intelligent Cool-ORing® solutions that can be used in reverse polarity applications. Information is available at vicorpower.com.

The PI31xx-00-HVMZ will draw nearly zero current until the input voltage reaches the internal start up threshold. If the ENABLE pin is not pulled low by external circuitry, the output voltage will begin rising to its final output value about 80ms after the input UV lockout releases. This will occur automatically even if the ENABLE pin is floating.

To help keep the source impedance low, the input to the PI31xx-00-HVMZ should be bypassed with (2) 4.7µF 50V ceramic capacitors of X7R dielectric in parallel with a low Q 100µF 63V electrolytic capacitor. To reduce EMI and reflected ripple current, a series inductor of 0.2 to 0.47µH can be added. The input traces to the module should be low impedance configured in such a manner as to keep stray inductance minimized.

ENABLE

The ENABLE pin serves as a multi-function pin for the PI31xx-00-HVMZ. During normal operation, it outputs the on-board 4.9V regulator which can be used for trimming the module up. The ENABLE pin can also be used as a remote enable pin either from the secondary via an optocoupler and an external isolated bias supply or from the primary side through a small signal transistor, FET, or any device that sinks 3.3mA, minimum. If the ENABLE pin is lower than 2.35V typical, the converter will be held off or shut down if already operating. A third feature is offered in that during a fault condition, such as output OVP, input UV or OV, or output current limit, the ENABLE pin is pulled low internally. This can be used as a signal to the user

that a fault has occurred. Whenever the ENABLE pin is pulled low, the TRIM/SS pin follows, resetting the internal and external soft-start circuitry. All faults will pull ENABLE low including over temperature. If increased turn on delay is desired, the ENABLE pin can be bypassed with a small capacitor up to a maximum of 1500pF.

TRIM/SS Pin

The TRIM/SS pin serves as another multi-purpose pin. First, it is used as the reference for the internal error amplifier. Connecting a resistor from TRIM/SS to SGND allows the reference to be margined down by as much as -20%. Connecting a resistor from TRIM/SS to ENABLE will allow the reference and output voltage to be margined up by 10%. If the user wishes a longer start up time, a small ceramic capacitor can be added to TRIM/SS to increase it. It is critical to connect any device between TRIM/SS and SGND and not -IN, otherwise high frequency noise will be introduced to the reference and possibly cause erratic operation. Referring to the figures below, the appropriate trim up or trim down resistor can be calculated using the equivalent circuit diagram and the equations. When trimming up, the trim down resistor is not populated. When trimming down, the trim up resistor is not populated. The soft start time is adjustable within the limits defined by the data tables and has a default value of 500µs to reach steady state. The internal soft start capacitor value is 10nF.

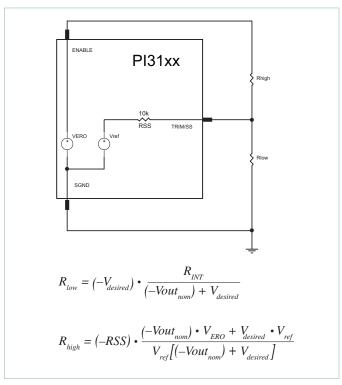


Figure 42 — Trim Equations And Equivalent Circuit

$$C_{REF} = \frac{T_{ssdesired} - 230 \cdot 10^{-6}}{23000}$$



TM

The TM pin serves as an output indicator of the internal package temperature which is within +/- 5°K of the hottest junction temperature. Because of this, it is a good indicator of a thermal overload condition. The output is a scaled, buffered analog voltage which indicates the internal temperature in degrees Kelvin. Upon a thermal overload, the TM pin is pulled low, indicating a thermal fault has occurred. Upon restart of the converter, the TM pin reverts back to a buffered monitor. The thermal shutdown function of the Pl31xx-00-HVMZ is a fault feature which interrupts power processing if a certain maximum temperature is exceeded. TM can be monitored by an external microcontroller or circuit configured as an adaptive fan speed controller so that air flow in the system can be conveniently regulated.

SGND

The PI31xx-00-HVMZ SGND pin is the "quiet" control circuitry return. It is basically an extension of the internal signal ground. To avoid contamination and potential ground loops, this ground should NOT be connected to -IN since it is already star connected inside the package. Connect signal logic to SGND, not -IN.

Output Power Pins +OUT And -OUT

The output power terminals OUT(+) and OUT(-) deliver the maximum output current from the PI31xx-00-HVMZ through the J-lead output pins. This configuration allows for a low impedance output and should be connected to multi-layer PCB parallel planes for best performance. Due to the high switching frequency, output ripple and noise can be easily attenuated by adding just a few high quality X7R ceramic capacitors while retaining adequate transient response for most applications. The PI31xx-00-HVMZ does not require any feedback loop compensation nor does it require any opto-isolation. All isolation is contained within the package. This greatly simplifies the use of the converter and eliminates all outside influences of noise on the quality of the output voltage regulation and feedback loop. It is important for the user to minimize resistive connections from the load to the converter output and to keep stray inductance to a minimum for best regulation and transient response. The very small size footprint and height of the PI31xx-00-HVMZ allows the converter to be placed in the optimum location to allow for tight connections to the point of load. For those applications absolutely requiring very tight regulation, contact Picor Engineering at vicorpower.com for a remote sense application circuit which can be used.



Package Outline & Recommended PCB Land Pattern

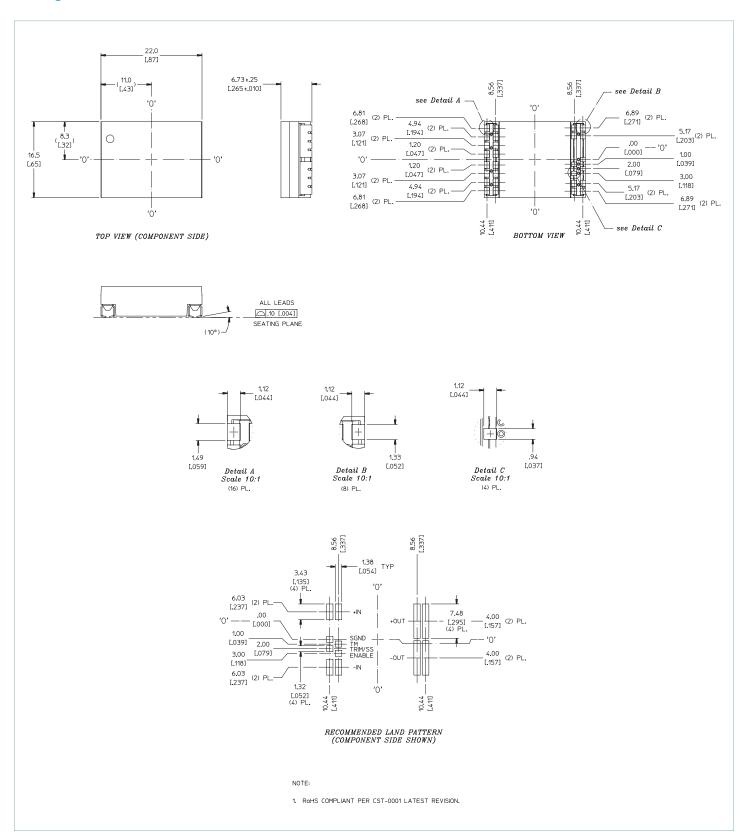


Figure 33 — Package Outline & Recommended PCB Land Pattern

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